

VUPB004R085NA

Datasheet





VUPB004R085NA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D	
40V	8.5mΩ@10V	42.4	
	12mΩ@4.5V	42A	

Symbol

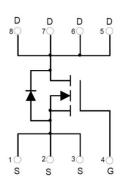
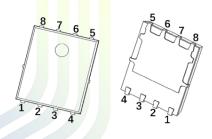


Figure 1 Symbol of VUPB004R085NA

Features

- Trench Technology Power MOSFET
- \blacksquare Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Package Type



Application

- Battery protection applications
- Power Switch Application

PDFN5X6-8L

Figure 2 Package Type of VUPB004R085NA

Ordering Information

Product Name	Package		
VUPB004R085NA	PDFN5X6-8L		



VUPB004R085NA

Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current ^{Note1} T _C = 25 °C	т	42	
Continuous Drain Current ^{Note1} T _C = 100°C	I_{D}	29	A
Pulsed Drain Current Note2	I_{DM}	168	
Single Pulsed Avalanche Energy ^{Note3}	Eas	156	mJ
Avalanche Current ^{Note3}	I _{AS}	25	A
Total Power Dissipation ^{Note5} $T_C=25$ °C	P _D	28	W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient Note6	$R_{\theta JA}$		65		°C/W
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		4.5		°C/W





VUPB004R085NA

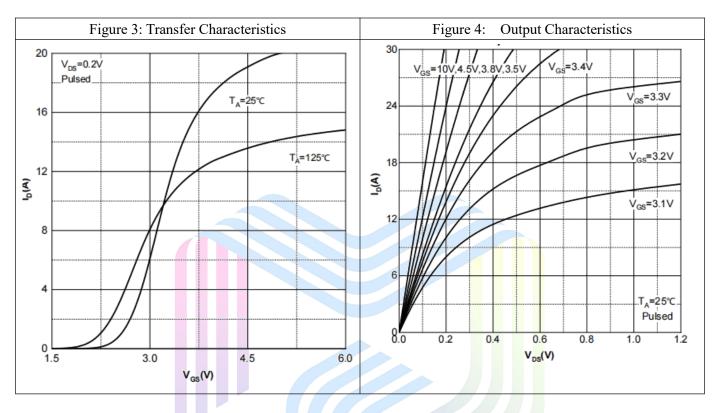
Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

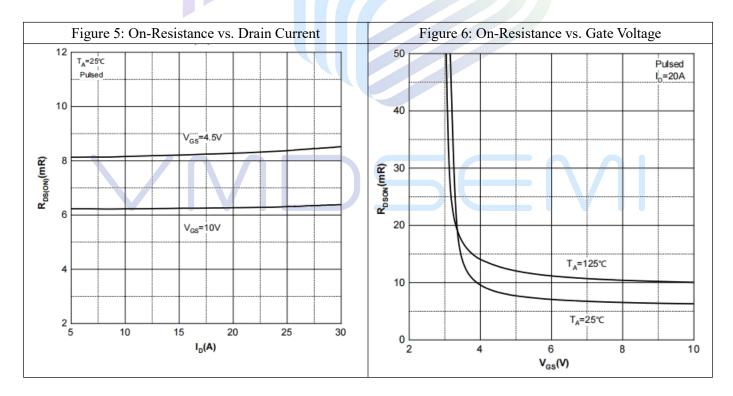
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	$\mathrm{BV}_{\mathrm{DSS}}$	$V_{GS}=0V, I_D=250uA$ 40				V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} =40V, V_{GS} =0V	V _{DS} =40V, V _{GS} =0V		1	uA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Gate Threshold Voltage ^{Note4}	$V_{\text{GS(th)}}$	$V_{DS}=V_{GS}$, $I_D=250uA$	1.0	1.7	3.0	V
Static Drain-Source On-Resistance ^{Note4}	D	$V_{GS}=10V, I_{D}=20A$		6.5	8.5	mΩ
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS} =4.5V, I_{D} = 20A		8.5	12	
Forward Transconductance ^{Note4}	gfs	$V_{DS}=5V, I_{D}=20A$		30		S
Dynamic Characteristics						
Input Capacitance	C _{ISS}	V _{DS} =20V		2876		pF
Output Capacitance	Coss	V _{GS} =0V		193		pF
Reverse Transfer Capacitance	C _{RSS}	f=1MHz		161		pF
Total Gate Charge	Q_{g}	V _{DS} =20V		52.0		
Gate-Source Charge	Q_{gs}	V _{GS} =10V		7.5		пC
Gate-Drain Charge	Q_{gd}	$I_D=20A$		9.7		
Gate Resistance	Rg	f = 1MHz, Open drain		1.97		Ω
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=20V$		6		
Turn-on Rise Time	$t_{\rm r}$	$V_{GS}=10V$		3		12 G
Turn-off Delay Time	$t_{d(off)}$	$I_D=20A$		25		ns
Turn-off Fall Time	t_{f}	$R_G=1.6\Omega$		4		
Diode Characteristics						
Diode Forward Voltage Note4	$ m V_{SD}$	$V_{GS}=0V, I_{S}=10A$			1.2	V

Notes:

- 1. The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2. Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3.E_{AS} condition: $V_{DD} = 25V$, $V_{GS} = 10V$, L = 0.5mH, $R_G = 25\Omega$ Starting $T_J = 25$ °C.
- 4. Pulse Test : Pulse Width $\leq 300 \mu s$, duty cycle $\leq 2\%$.
- 5. The power dissipation P_D is limited by $T_{J(MAX)} = 150$ °C. And device mounted on a large heatsink
- 6.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

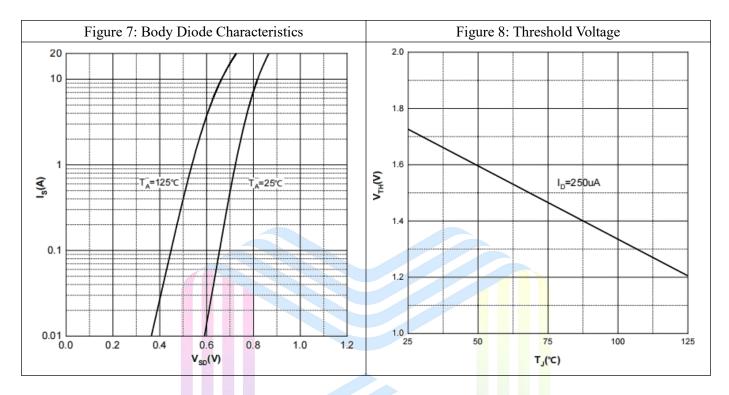
Typical Performance Characteristics

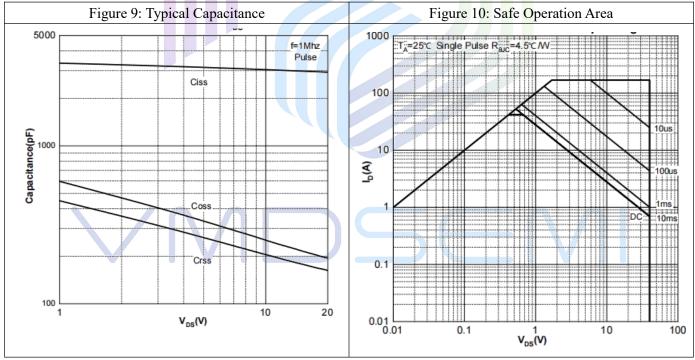






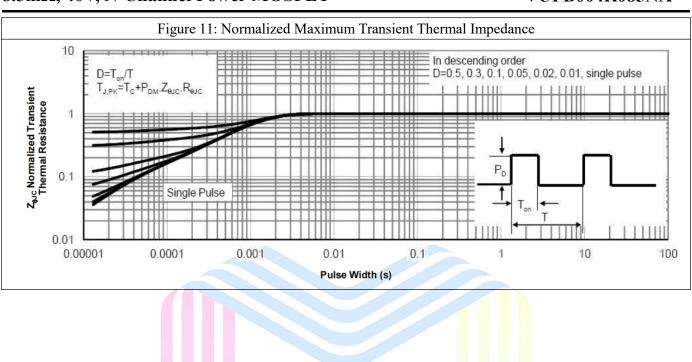
VUPB004R085NA







VUPB004R085NA

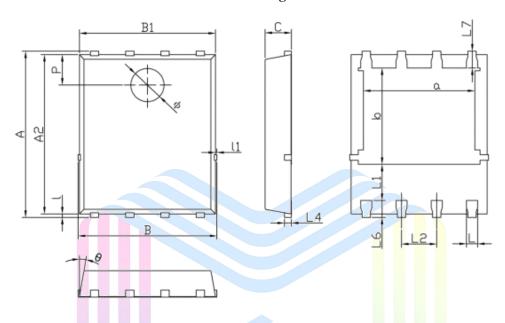




VUPB004R085NA

Mechanical Dimensions:

PDFN5X6-8L Package Information



Cumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	5.900	6.100	0.232	0.240	
а	3.910	4.110	0.154	0.162	
A2	5.700	5.800	0.224	0.228	
В	4.900	5.100	0.193	0.201	
b	3.370	3.570	0.133	0.141	
B1	4.800	5.000	0.189	0.197	
С	0.900	1.000	0.035	0.039	
L	0.350	0.450	0.014	0.018	
1	0.060	0.200	0.002	0.008	
L1	1.100	-	0.043	/	
l1		0.100		0.004	
L2	1.170	1.370	0.046	0.054	
L4	0.210	0.340	0.008	0.013	
L6	0.510	0.710	0.020	0.028	
L7	0.510	0.710	0.020	0.028	
Р	1.000	1.200	0.039	0.047	
Ф	1.100	1.300	0.043	0.051	
θ	8°	12°	8°	12°	



VUPB004R085NA

NOTICE

Hangzhou VMD Semiconductor Co., Ltd (VMD) reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information is current and complete. All products are sold subject to VMD's terms and conditions supplied at the time of order acknowledgement.

VMD, its affiliates, agents, and employees, and all persons acting on its or their behalf, disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

VMD disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify VMD's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

VMD warrants performance of its hardware products to the specifications at the time of sale, testing, reliability and quality control are used to the extent VMD deems necessary to support this warrantee. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

VMD does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using VMD's components. To minimize risk, customers must provide adequate design and operating safeguards.

VMD does not warrant or convey any license to any intellectual property rights either expressed or implied under its patent rights, nor the rights of others. Reproduction of information in VMD's data sheets or data books is permissible only if reproduction is without modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice.

VMD is not responsible or liable for such altered documentation. Resale of VMD's products with statements different from or beyond the parameters stated by VMD for that product or service voids all express or implied warrantees for the associated VMD product or service and is an unfair and deceptive business practice.

All Rights Reserved.





Via-Media Semiconductor Limited Company

http://www.vmdsemi.com

Main Sites:

- Headquarters

Hangzhou Via-Media Semiconductor Co., LTD. 1305-1306, Building 71, No. 90, Wensan Road, Xihu District, Hangzhou, Zhejiang Province, P.R. China Tel: +86-0571-8515 0563

- Shanghai

Shanghai R&D Center. 1506~1508, Xinyin Building, 888 Yishan Road, Shanghai, P.R of China Tel: +86- 021-54201999

- Xi'an

Xi'an R&D Center 1703B, Building A, Greenland Center, Jinye Road, High-Tech Zone, Xi'an, Shaanxi, P.R of China

- Chengdu Office

Chengdu Winhi Semiconductor Co., LTD. Floor 15, Building 5, No. 171, Hele 2nd Street, Chengdu, Sichuan Province, P.R. China Tel: +86-028-8505 0771

Shenzhen

Shenzhen Sales office
Room 4A15, Block AB, Tianxiang Building,
Chegongmiao, Futian District, Shenzhen, P.R of China
Tel: +86-0755-82570682